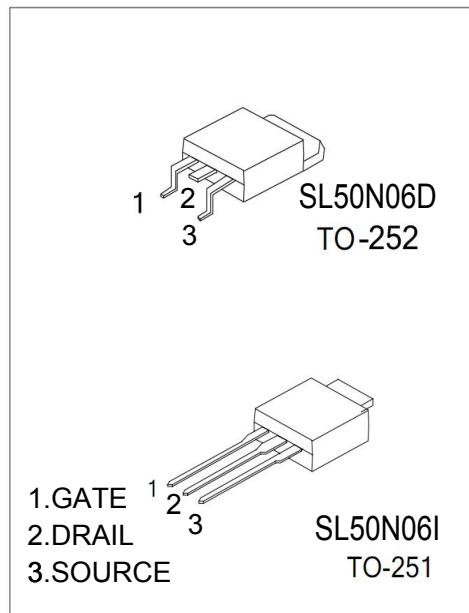


N-Channel 60-V(D-S) Power MOSFET

V(BR)DSS	RDS(on)MAX	ID
60 V	20mΩ@ 10 V	50A

Equivalent Circuit:



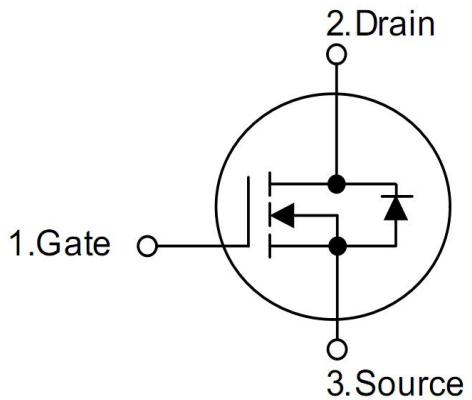
General Description:

The high voltage MOSFET uses an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition , this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes . The new energy efficient design also offers a drain-to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power suppliers, converters and PWM motor controls , these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.

FEATURE:

- ※ Power switching application
- ※ Hard switched and high frequency circuits
- ※ Uninterruptible power supply
- ※ Fully characterized avalanche voltage and current
- ※ Excellent package for good heat dissipation
- ※ Good stability and uniformity with high EAS

SYMBOL:



Maximum ratings (Ta=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	VDS	60	V
Gate-Source Voltage	VGS	±20	
Continuous Drain Current	ID	50	A
Pulsed Diode Current	IDM	150	
Power Dissipation	PD	136	W
Thermal Resistance from Junction to Ambient (t≤10s)	R _{θJA}	100	°C/W
Operating Junction	T _J	150	°C
Storage Temperature	T _{STG}	-55~+150	

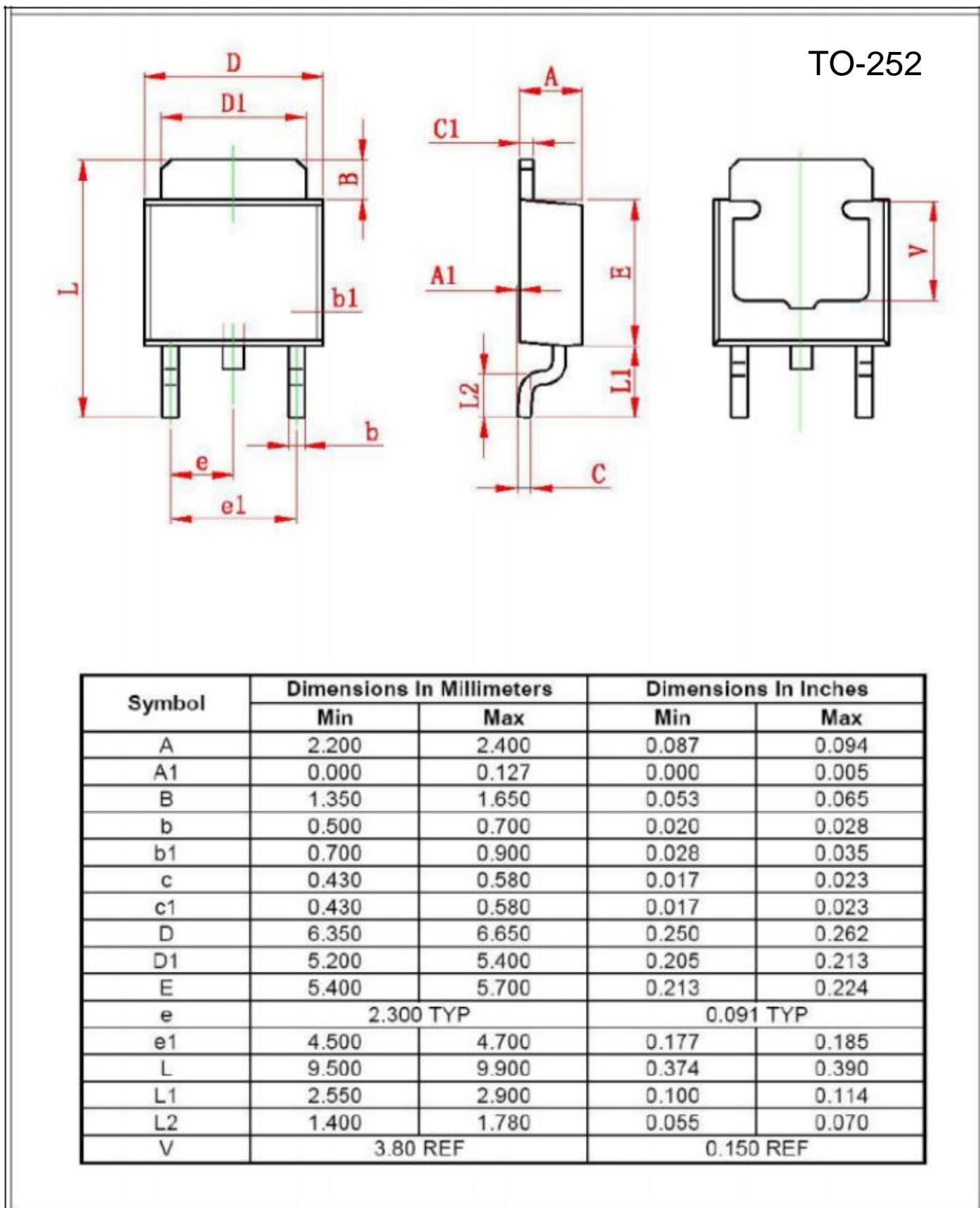
MOSFET ELECTRICAL CHARACTERISTICS**Static Electrical Characteristics (Ta = 25 °C Unless Otherwise Noted)**

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Drain-source breakdown voltage	V(BR)DSS	VGS = 0V, ID = 250µA	60			V
Gate-source threshold voltage	VGS(th)	VDS = VGS, ID = 250µA	1.2		2.5	V
Gate-source leakage	IGSS	VDS = 0V, VGS = ±20V			±100	nA
Zero gate voltage drain current	IDSS	VDS = 60V, VGS = 0V			1	µA
Drain-source on-state resistancea	RDS(on)	VGS = 10V, ID = 30A		14.5	20	mΩ
Forward transconductancea	gfs	VDS = 25V, ID = 25A	24			S
Diode forward voltage	VSD	IS= 10A, VGS=0V		0.8	1.3	V
Dynamic						
Input capacitance	Ciss	VDS = 25V, VGS = 0V, f=1MHz		900		pF
Output capacitance	Coss			104		pF
Reverse transfer capacitanceb	Crss			33		pF
Total gate charge	Qg	VDS = 25V, VGS = 10V, ID = 50A		30		nC
Gate-source charge	Qgs			10		nC
Gate-drain charge	Qgd			5		nC
Switchingb						
Turn-on delay time	td(on)	VDD=30 V RL= 25Ω, ID = 25A, VGEN= 10V, Rg= 25Ω		25		ns
Rise time	tr			5		ns
Turn-off delay time	td(off)			50		ns
Fall time	tf			6		ns
Drain-Source Diode Characteristics						
Continuous Source-Drain Diode Current	IS				50	A
Pulsed Diode forward Current	ISM				220	A

Note :

1. Repetitive Rating : Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t < 10 sec.
3. Pulse Test : Pulse Width≤300µs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production testing.

PACKAGE OUTLINE DIMENSIONS :



PACKAGE OUTLINE DIMENSIONS :

